

FULL 50-60Hz RECTIFICATION BRIDGE

PRELIMINARY DATASHEET

MAIN PRODUCT CHARACTERISTICS

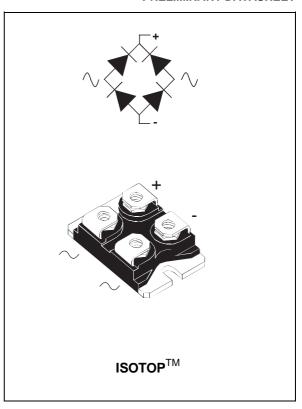
I _{F(AV)}	35 A
V _{RRM}	1000 V
Tj (max)	150 ℃
V _F (max)	1.30 V

FEATURES AND BENEFITS

- COMPACT ISOTOP DESIGN COMPATIBLE WITH FAST DIODES AND TRANSISTORS.
- EXCELLENT THERMAL TRANSFER BETWEEN JUNCTION AND HEATSINK
- **UL PENDING**

DESCRIPTION

The Bridges series from ST Microelectronics has been designed to allow a better standardization of packages on boards principally designed with ISO-TOP packages. The insulated package of the bridge will be able to sit on heatsink with other components. Single phase and 3-phase high power SMPS, UPS, MOTOR DRIVES and WELD-ING equipment will primarily find advantage in these industry package products.



ABSOLUTE RATINGS AND ELECTRICAL CHARACTERISTICS (per diode unless specified)

Symbol	Param	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		1000	V
V _{RSM}	Non repetitive peak reverse voltage		1000	V
I _{F(AV)} total	Average forward current Tc = 80°C sinusoidal		35	Α
I _{FSM}	Surge non repetitive forward current 50Hz JEDEC method		300	Α
l ² .t	Fusing	660	A ² .s	
T _{stg}	Storage temperature range	- 55 to + 150	°C	
Tj	Maximum operating junction te	150	°C	
Pmax total	Totol power dissipation	50	W	

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BF3510TV

THERMAL RESISTANCES

Symbol	Parameter	Value	Unit	
Rth (j-c)	Junction to case	total	0.5	°C/W

ELECTRICAL CHARACTERISTICS (Per diode) STATIC CHARACTERISTICS

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _R *	Reverse leakage current	$V_R = 0.8 V_{RRM}$ $\delta < 2\%$	T _j = 25°C			10	μΑ
		tp = 5ms	T _j = 125°C			0.2	mA
VF **		I _F = 35 A δ < 2%	T _j = 25°C			1.4	V
drop	tp = 380μs	T _j = 125°C			1.3	V	

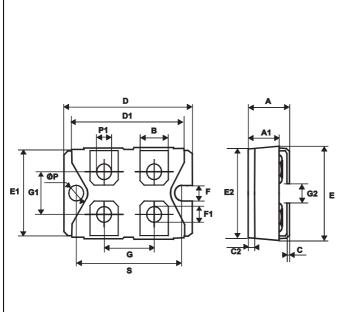
Pulse test : * tp = 5 ms, duty cycle < 2%** tp = 380 μ s, duty cycle < 2%

For one diode: $Pcond = 1.02 \times I_{F(AV)} + 0.008 \times I_{F(RMS)}^2$ $Tj = Pcond \times 4 \times R_{th(j-c)} + Tc$

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PACKAGE MECHANICAL DATA

ISOTOP (Plastic)



DIMENSIONS					
REF.	Millin	neters	Inches		
	Min. Max.		Min.	Max.	
Α	11.80	12.20	0.465	0.480	
A1	8.90	9.10	0.350	0.358	
В	7.8	8.20	0.307	0.323	
С	0.75	0.85	0.030	0.033	
C2	1.95	2.05	0.077	0.081	
D	37.80	38.20	1.488	1.504	
D1	31.50	31.70	1.240	1.248	
Е	25.15	25.50	0.990	1.004	
E1	23.85	24.15	0.939	0.951	
E2	24.80) typ.	0.976	S typ.	
G	14.90	15.10	0.587	0.594	
G1	12.60	12.80	0.496	0.504	
G2	3.50	4.30	0.138	0.169	
F	4.10	4.30	0.161	0.169	
F1	4.60	5.00	0.181	0.197	
Р	4.00	4.30	0.157	0.69	
P1	4.00	4.40	0.157	0.173	
S	30.10	30.30	1.185	1.193	

Cooling method : by conduction (C) Electrical isolation : 2500V_(RMS) Capacitance : < 45 pF Inductance : < 5 nH

⁻ The screws supplied with the package are adapted for mounting on a board (or other types of terminals) with a thickness of 0.6 mm min and 2.2 mm max.

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
BF3510TV	BF3510TV	ISOTOP	27g without screws	10	Tube

■ Epoxy meets UL94,V0

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⁻ Recommended torque value: 1.3 N.m (MAX 1.5 N.m) for the 6 x M4 screws. (2 x M4 screws recommended for mounting the package on the heatsink and the 4 screws given with the screw version).